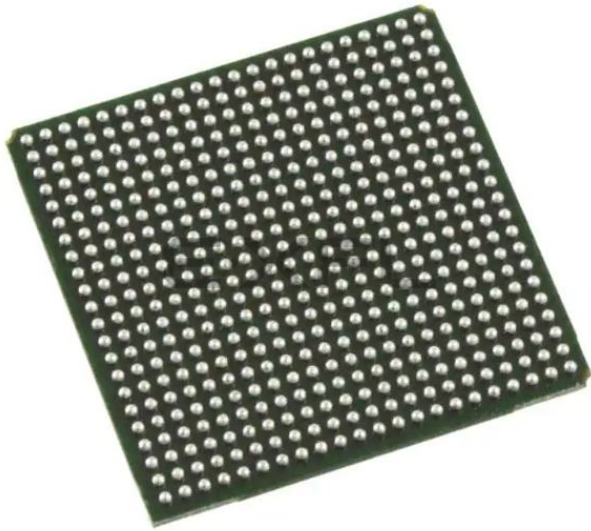




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

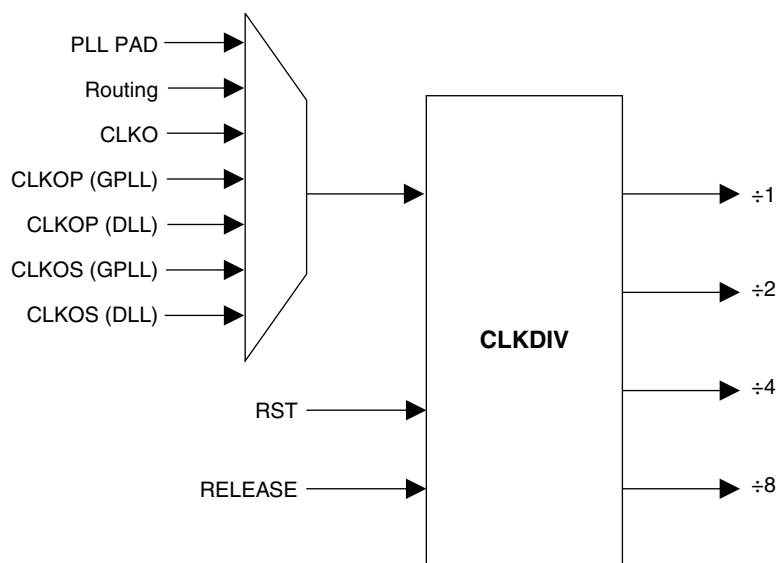
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	297
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12se-5f484c

Figure 2-9. Clock Divider Connections



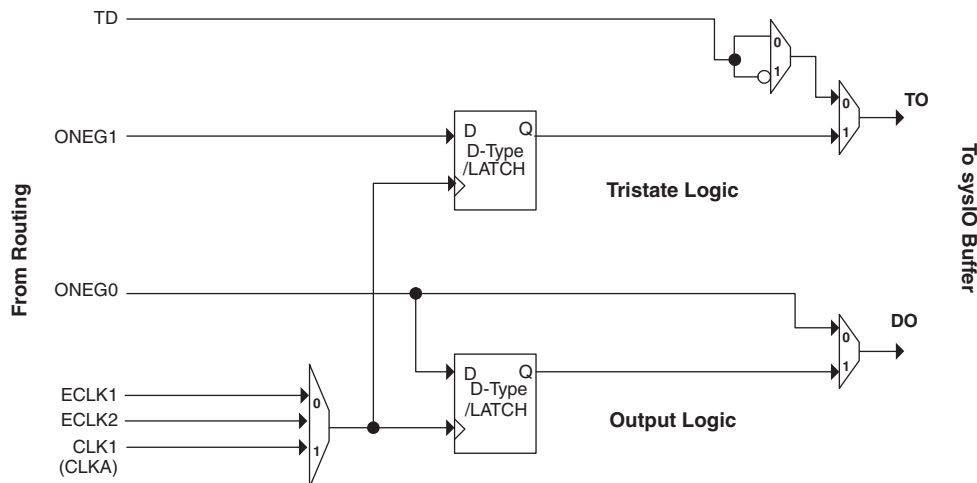
Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLK-DIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

Figure 2-32. Output and Tristate Block, Top Edge



Note: Simplified version does not show CE and SET/RESET details.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sys/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block with the Output Block for the left, right and bottom edges and Figure 2-32 shows the diagram of the Tristate Register Block with the Output Block for the top edge.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 and OPOS1 are fed into registers on the positive edge of the clock. Then in the next clock the registered OPOS1 is latched. A multiplexer running off the same clock cycle selects the correct register for feeding to the output (DO).

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing, one of the edge clocks (ECLK1/ ECLK2) and a DQS signal provided from the programmable DQS pin and provided to the input register block. The clock can optionally be inverted.

DDR Memory Support

Certain PICs have additional circuitry to allow the implementation of high speed source synchronous and DDR memory interfaces. The support varies by the edge of the device as detailed below.

Left and Right Edges

PICs on these edges have registered elements that support DDR memory interfaces. One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 16 PIOs. Figure 2-33 shows the assignment of DQS pins in each set of 16 PIOs.

Bottom Edge

PICs on the bottom edge have registered elements that support DDR memory interfaces. One of every 18 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 18 PIOs. Figure 2-34 shows the assignment of DQS pins in each set of 18 PIOs.

LatticeECP2/M External Switching Characteristics⁹

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) ¹									
t _{CO}	Clock to Output - PIO Output Register	LFE2-6	—	3.50	—	3.90	—	4.20	ns
		LFE2-12	—	3.50	—	3.90	—	4.20	ns
		LFE2-20	—	3.50	—	3.90	—	4.20	ns
		LFE2-35	—	3.50	—	3.90	—	4.20	ns
		LFE2-50	—	3.50	—	3.90	—	4.20	ns
		LFE2-70	—	3.70	—	4.10	—	4.40	ns
		LFE2M20	—	3.90	—	4.30	—	4.70	ns
		LFE2M35	—	3.90	—	4.30	—	4.70	ns
		LFE2M50	—	4.50	—	5.00	—	5.40	ns
		LFE2M70	—	4.50	—	5.00	—	5.40	ns
		LFE2M100	—	4.50	—	5.00	—	5.40	ns
t _{SU}	Clock to Data Setup - PIO Input Register	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
t _H	Clock to Data Hold - PIO Input Register	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.80	—	2.10	—	2.30	—	ns
		LFE2M70	1.80	—	2.10	—	2.30	—	ns
		LFE2M100	1.80	—	2.10	—	2.30	—	ns

Figure 3-7. DDR and DDR2 Parameters

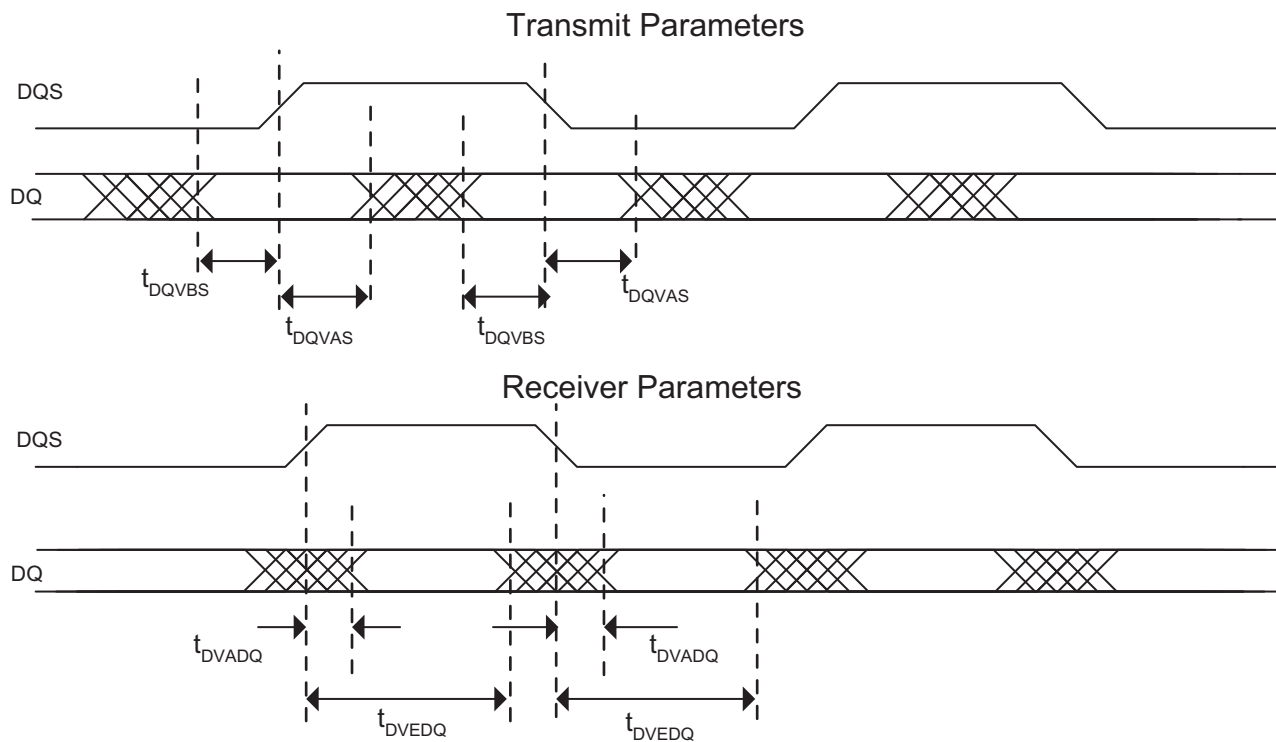
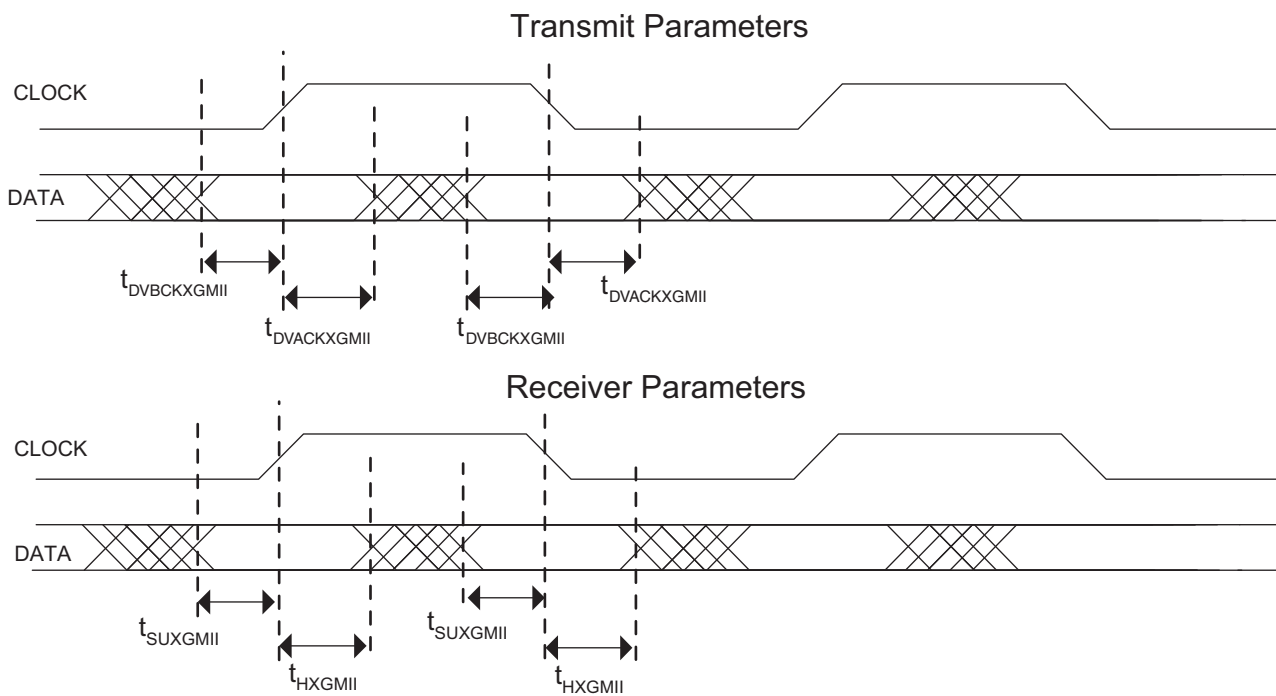


Figure 3-8. XGMII Parameters



LatticeECP2/M Family Timing Adders^{1, 2, 3}
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
Input Adjusters					
LVDS25	LVDS	-0.04	-0.02	0.00	ns
BLVDS25	BLVDS	-0.04	-0.09	-0.15	ns
MLVDS	LVDS	-0.15	-0.15	-0.15	ns
RSDS	RSDS	-0.15	-0.15	-0.15	ns
LVPECL33	LVPECL	0.16	0.15	0.13	ns
HSTL18_I	HSTL_18 class I	0.01	-0.01	-0.04	ns
HSTL18_II	HSTL_18 class II	0.01	-0.01	-0.04	ns
HSTL18D_I	Differential HSTL 18 class I	0.01	-0.01	-0.04	ns
HSTL18D_II	Differential HSTL 18 class II	0.01	-0.01	-0.04	ns
HSTL15_I	HSTL_15 class I	0.01	-0.01	-0.04	ns
HSTL15D_I	Differential HSTL 15 class I	0.01	-0.01	-0.04	ns
SSTL33_I	SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33_II	SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL33D_I	Differential SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33D_II	Differential SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL25_I	SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25_II	SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL25D_I	Differential SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25D_II	Differential SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL18_I	SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18_II	SSTL_18 class II	-0.01	-0.04	-0.07	ns
SSTL18D_I	Differential SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18D_II	Differential SSTL_18 class II	-0.01	-0.04	-0.07	ns
LVTTTL33	LVTTTL	-0.16	-0.16	-0.16	ns
LVC MOS33	LVC MOS 3.3	-0.08	-0.12	-0.16	ns
LVC MOS25	LVC MOS 2.5	0.00	0.00	0.00	ns
LVC MOS18	LVC MOS 1.8	-0.16	-0.17	-0.17	ns
LVC MOS15	LVC MOS 1.5	-0.14	-0.14	-0.14	ns
LVC MOS12	LVC MOS 1.2	-0.04	-0.01	0.01	ns
PCI33	PCI	-0.08	-0.12	-0.16	ns
Output Adjusters					
LVDS25E	LVDS 2.5 E ⁴	0.25	0.19	0.13	ns
LVDS25	LVDS 2.5	0.10	0.13	0.17	ns
BLVDS25	BLVDS 2.5	0.00	-0.01	-0.03	ns
MLVDS	MLVDS 2.5 ⁴	0.00	-0.01	-0.03	ns
RSDS	RSDS 2.5 ⁴	0.25	0.19	0.13	ns
LVPECL33	LVPECL 3.3 ⁴	-0.02	-0.04	-0.06	ns
HSTL18_I	HSTL_18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18_II	HSTL_18 class II	-0.30	-0.34	-0.37	ns
HSTL18D_I	Differential HSTL 18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18D_II	Differential HSTL 18 class II	-0.30	-0.34	-0.37	ns

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPI _m mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPI _m . When using the SPI or SPI _m mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPI _m
DOUT/CSN	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPI _m modes.
Dedicated SERDES Signals^{1, 2, 3}		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCI _{Bm}	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCO _{Bm}	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOU _{TNm}	O	High-speed output, negative channel m
[LOC]_SQ_HDOU _{TPm}	O	High-speed output, positive channel m
[LOC]_SQ_HDIN _{Nm}	I	High-speed input, negative channel m
[LOC]_SQ_HDIN _{Pm}	I	High-speed input, positive channel m
[LOC]_SQ_VCCT _{Xm} ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR _{Xm} ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	2	2	2	4	4	4	4
	Bank3	2	1	1	3	4	3	5
	Bank4	3	1	3	3	3	3	3
	Bank5	2	3	3	2	3	2	3
	Bank6	1	2	2	3	4	3	5
	Bank7	3	3	3	4	4	4	5
	Bank8	0	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	0	0	0	0	72	0	80
	Bank3	0	0	0	0	64	0	80
	Bank4	50	24	48	48	40	48	44
	Bank5	60	60	50	40	40	40	46
	Bank6	52	54	60	62	66	62	82
	Bank7	60	60	68	70	74	70	90
	Bank8	0	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

Available Device Resources by Package, LatticeECP2

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA
PLL/DLL	ECP2-6	4	—	—	—
	ECP2-12	4	4	—	—
	ECP2-20	4	4	4	—
	ECP2-35	—	4	4	—
	ECP2-50	—	6	6	—
	ECP2-70	—	—	8	8

Available Device Resources by Package, LatticeECP2M

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA	1152 fpBGA
PLL/DLL	ECP2M20	10	10	—	—	—
	ECP2M35	10	10	10	—	—
	ECP2M50	—	10	10	10	—
	ECP2M70	—	—	—	10	10
	ECP2M100	—	—	—	10	10

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C3	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
C2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
-	-	-			-	-			
D3	PL5A	7		T	PL5A	7		T	
D4	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*	
D2	PL5B	7		C	PL5B	7		C	
GND	GNDIO7	-			GNDIO7	-			
E4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*	
B1	PL7A	7	LDQ10	T	PL7A	7	LDQ10	T	
C1	PL7B	7	LDQ10	C	PL7B	7	LDQ10	C	
F5	PL9A	7	LDQ10	T	PL9A	7	LDQ10	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F4	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*	
G6	PL9B	7	LDQ10	C	PL9B	7	LDQ10	C	
G4	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*	
D1	PL10A	7	LDQS10	T (LVDS)*	PL10A	7	LDQS10	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
E1	PL10B	7	LDQ10	C (LVDS)*	PL10B	7	LDQ10	C (LVDS)*	
F3	PL11A	7	LDQ10	T	PL11A	7	LDQ10	T	
G3	PL11B	7	LDQ10	C	PL11B	7	LDQ10	C	
VCCIO	VCCIO7	7			VCCIO7	7			
F2	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*	
F1	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
G2	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T	
G1	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C	
H6	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
H5	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*	
H4	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T	
GND	GNDIO6	-			GNDIO6	-			
H3	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C	
H2	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	
H1	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	
G10	VCC	-			VCC	-			
J4	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T	
J5	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C	
J6	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
K4	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
J1	PL21A	6	LLM0_GPLLT_FB_A	T	PL21A	6	LLM0_GPLLT_FB_A	T	
K3	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
J2	PL21B	6	LLM0_GPLLC_FB_A	C	PL21B	6	LLM0_GPLLC_FB_A	C	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R8	VCCIO6	6			VCCIO6	6		
J8	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
L7	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
P15	VCCIO8	8			VCCIO8	8		
R15	VCCIO8	8			VCCIO8	8		
C5	VCCAUX	-			VCCAUX	-		
D11	VCCAUX	-			VCCAUX	-		
E17	VCCAUX	-			VCCAUX	-		
E6	VCCAUX	-			VCCAUX	-		
F13	VCCAUX	-			VCCAUX	-		
G18	VCCAUX	-			VCCAUX	-		
G5	VCCAUX	-			VCCAUX	-		
K5	VCCAUX	-			VCCAUX	-		
M17	VCCAUX	-			VCCAUX	-		
P17	VCCAUX	-			VCCAUX	-		
R5	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V13	VCCAUX	-			VCCAUX	-		
V15	VCCAUX	-			VCCAUX	-		
V7	VCCAUX	-			VCCAUX	-		
V8	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
C14	GND	-			GND	-		
C9	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
F17	GND	-			GND	-		
F6	GND	-			GND	-		
H10	GND	-			GND	-		
H11	GND	-			GND	-		
H12	GND	-			GND	-		
H13	GND	-			GND	-		
J14	GND	-			GND	-		
J20	GND	-			GND	-		
J3	GND	-			GND	-		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
U9	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
W9	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-			GNDIO5	-		
V9	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
Y8	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AA8	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
W10	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
V10	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
AB8	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AA9	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
AB9	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AB10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
Y10	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
AA10	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
U10	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
U11	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
AB11	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AA11	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y11	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
W11	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AB12	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AA12	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AB13	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T
AB14	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
GNDIO	GNDIO5	-			GNDIO5	-		
U12	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
V12	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C
Y12	PB41A	4	BDQ42	T	PB50A	4	BDQ51	T
W12	PB41B	4	BDQ42	C	PB50B	4	BDQ51	C
AA13	PB42A	4	BDQS42	T	PB51A	4	BDQS51	T
GNDIO	GNDIO4	-			GNDIO4	-		
Y13	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
U13	PB43A	4	BDQ42	T	PB52A	4	BDQ51	T
U14	PB43B	4	BDQ42	C	PB52B	4	BDQ51	C
AB15	PB44A	4	BDQ42	T	PB53A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
AA14	PB44B	4	BDQ42	C	PB53B	4	BDQ51	C
AB16	PB45A	4	BDQ42	T	PB54A	4	BDQ51	T
AB17	PB45B	4	BDQ42	C	PB54B	4	BDQ51	C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U1	NC	-			PL34A	6	LDQ31	T	
V1	NC	-			PL34B	6	LDQ31	C	
GND	GNDIO6	-			GNDIO6	-			
P3	NC	-			NC	-			
R3	NC	-			NC	-			
R4	NC	-			NC	-			
U2	NC	-			NC	-			
VCCIO	VCCIO6	6			VCCIO6	6			
V2	NC	-			NC	-			
W2	NC	-			NC	-			
T6	NC	-			PL38A	6	LDQ39	T	
R5	NC	-			PL38B	6	LDQ39	C	
GND	GNDIO6	-			GNDIO6	-			
R6	PL25A	6	LDQS25***	T (LVDS)*	PL39A	6	LDQS39***	T (LVDS)*	
R7	PL25B	6	LDQ25	C (LVDS)*	PL39B	6	LDQ39	C (LVDS)*	
W1	PL26A	6	LDQ25	T	PL40A	6	LDQ39	T	
VCCIO	VCCIO6	6			VCCIO6	6			
Y2	PL26B	6	LDQ25	C	PL40B	6	LDQ39	C	
Y1	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	PL41A	6	LLM0_GDLLT_IN_A**/LDQ39	T (LVDS)*	
AA2	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	PL41B	6	LLM0_GDLLC_IN_A**/LDQ39	C (LVDS)*	
T5	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T	PL42A	6	LLM0_GDLLT_FB_A/LDQ39	T	
GND	GNDIO6	-			GNDIO6	-			
T7	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C	PL42B	6	LLM0_GDLLC_FB_A/LDQ39	C	
R8	VCC	6			VCCPLL	6			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
U3	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	PL44A	6	LLM0_GPLLT_IN_A**/LDQ48	T (LVDS)*	
U4	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	PL44B	6	LLM0_GPLLC_IN_A**/LDQ48	C (LVDS)*	
V3	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	PL45A	6	LLM0_GPLLT_FB_A/LDQ48	T	
U5	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	PL45B	6	LLM0_GPLLC_FB_A/LDQ48	C	
V4	PL32A	6	LDQ34	T (LVDS)*	PL46A	6	LDQ48	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
V5	PL32B	6	LDQ34	C (LVDS)*	PL46B	6	LDQ48	C (LVDS)*	
Y3	PL33A	6	LDQ34	T	PL47A	6	LDQ48	T	
Y4	PL33B	6	LDQ34	C	PL47B	6	LDQ48	C	
W3	PL34A	6	LDQS34	T (LVDS)*	PL48A	6	LDQS48	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
W4	PL34B	6	LDQ34	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*	
AA1	PL35A	6	LDQ34	T	PL49A	6	LDQ48	T	
AB1	PL35B	6	LDQ34	C	PL49B	6	LDQ48	C	
VCCIO	VCCIO6	6			VCCIO6	6			
U8	PL36A	6	LDQ34	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*	
U7	PL36B	6	LDQ34	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*	
V8	PL37A	6	LDQ34	T	PL51A	6	LDQ48	T	
U6	PL37B	6	LDQ34	C	PL51B	6	LDQ48	C	
GND	GNDIO6	-			GNDIO6	-			
W6	PL38A	6	LDQ42	T (LVDS)*	PL52A	6	LDQ56	T (LVDS)*	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F14	PR24B	2	RDQ22	C (LVDS)*	PR34B	2	RDQ32	C(LVDS)*	
F13	PR24A	2	RDQ22	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*	
VCCIO	VCCIO2	2			VCCIO2	2			
GNDIO	GNDIO2	-			GNDIO2	-			
H11	PR14B	2		C	PR14B	2	RDQ15	C	
G11	PR14A	2		T	PR14A	2	RDQ15	T	
E13	PR13B	2		C (LVDS)*	PR13B	2	RDQ15	C(LVDS)*	
F12	PR13A	2		T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*	
VCCIO	VCCIO2	2			VCCIO2	2			
F11	PR12B	2	RUM0_SPLLC_FB_A	C	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C	
E12	PR12A	2	RUM0_SPLLT_FB_A	T	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T	
D16	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C(LVDS)*	
D15	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	
C16	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C	
GNDIO	GNDIO2	-			GNDIO2	-			
B16	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T	
VCCIO	VCCIO2	2			VCCIO2	2			
F4	XRES	-			XRES	-			
C15	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12			
A14	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T	
B15	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12			
B14	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C	
C12	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12			
A11	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T	
A12	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12			
B11	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C	
C11	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12			
B10	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C	
C10	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12			
A10	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T	
C14	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12			
B13	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C	
C13	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12			
A13	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T	
B9	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12			
D8	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C	
D9	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T	
C9	URC_SQ_VCCP	12			URC_SQ_VCCP	12			
A5	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T	
C5	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12			
B5	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C	
C4	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12			
A8	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T	
C8	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12			
B8	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C	
C7	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12			
B7	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C	
A6	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F11	VCCIO0	0			VCCIO0	0			
J13	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	1			
D18	VCCIO1	1			VCCIO1	1			
F16	VCCIO1	1			VCCIO1	1			
J14	VCCIO1	1			VCCIO1	1			
K15	VCCIO1	1			VCCIO1	1			
G25	VCCIO2	2			VCCIO2	2			
L21	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M25	VCCIO2	2			VCCIO2	2			
N18	VCCIO2	2			VCCIO2	2			
P18	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R25	VCCIO3	3			VCCIO3	3			
T21	VCCIO3	3			VCCIO3	3			
Y25	VCCIO3	3			VCCIO3	3			
AA16	VCCIO4	4			VCCIO4	4			
AC18	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V14	VCCIO4	4			VCCIO4	4			
AA11	VCCIO5	5			VCCIO5	5			
V13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AE7	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
P9	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R2	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
Y2	VCCIO6	6			VCCIO6	6			
G2	VCCIO7	7			VCCIO7	7			
L6	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M2	VCCIO7	7			VCCIO7	7			
N9	VCCIO7	7			VCCIO7	7			
AC24	VCCIO8	8			VCCIO8	8			
U17	VCCIO8	8			VCCIO8	8			
J11	VCCAUX	-			VCCAUX	-			
J12	VCCAUX	-			VCCAUX	-			
J15	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
M18	VCCAUX	-			VCCAUX	-			
M9	VCCAUX	-			VCCAUX	-			
R18	VCCAUX	-			VCCAUX	-			
R9	VCCAUX	-			VCCAUX	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T	
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C	
GNDIO	GNDIO7	-			GNDIO7	-			
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
GNDIO	GNDIO7	-			-	-			
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
E2	PL14A	7		T	PL14A	7	LDQ15	T	
D1	PL14B	7		C	PL14B	7	LDQ15	C	
-	-	-			GNDIO7	-			
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*	
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*	
K7	NC	-			PL16A	7	LDQ15	T	
K8	NC	-			PL16B	7	LDQ15	C	
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*	
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*	
F1	NC	-			PL18A	7	LDQ15	T	
-	-	-			GNDIO7	-			
G3	NC	-			PL18B	7	LDQ15	C	
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*	
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*	
J5	PL16A	7		T	PL22A	7		T	
J4	PL16B	7		C	PL22B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*	
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*	
L9	NC	-			PL25A	7	LDQ28	T	
L7	NC	-			PL25B	7	LDQ28	C	
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*	
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*	
L8	NC	-			PL27A	7	LDQ28	T	
L6	NC	-			PL27B	7	LDQ28	C	
-	-	-			GNDIO7	-			
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*	
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*	
N8	PL19A	7		T	PL29A	7	LDQ28	T	
M9	PL19B	7		C	PL29B	7	LDQ28	C	
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*	
VCCIO	VCCIO7	7			-	-			
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*	
H1	PL21A	7		T	PL31A	7	LDQ28	T	
GNDIO	GNDIO7	-			GNDIO7	-			
J1	PL21B	7		C	PL31B	7	LDQ28	C	
-	-	-			-	-			
-	-	-			-	-			

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5F1152C	520	1.2V	-5	fpBGA	1152	COM	100
LFE2M100E-6F1152C	520	1.2V	-6	fpBGA	1152	COM	100
LFE2M100E-7F1152C	520	1.2V	-7	fpBGA	1152	COM	100
LFE2M100E-5F900C	416	1.2V	-5	fpBGA	900	COM	100
LFE2M100E-6F900C	416	1.2V	-6	fpBGA	900	COM	100
LFE2M100E-7F900C	416	1.2V	-7	fpBGA	900	COM	100

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100